

High Current, High Frequency, Low-Profile Power Inductors

FLAT-PAC™ FP0805 Series



Description

- Halogen free
- 125°C maximum total temperature operation
- 7.5 x 7.6 x 5mm surface mount package
- · Ferrite core material
- · High current carrying capacity, Low core losses
- Controlled DCR tolerance for sensing circuits
- Inductance range from 32nH to 200nH
- Current range from 20 to 110 Amps
- Frequency range up to 2MHz
- · RoHS compliant

Applications

- Multi-phase regulators
- Voltage Regulator Module (VRM)
- · Point-of-load modules
- Desktop and server VRM's and EVRD's
- · Data networking and storage systems
- Notebook regulators
- Graphics cards and battery power systems
- DCR sensing

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (Range is application specific)
- Solder reflow temperature: J-STD-020D compliant

Packaging

• Supplied in tape and reel packaging, 950 parts per reel, 13 inch diameter reel.

	Product Specifications						
Part Number ⁷	OCL1 ± 10% (nH)	FLL ² Min. (nH)	I _{rms} ³ (Amps)	I _{sat} 1 ⁴ @ 25°C (Amps)	I _{sat} 2 ⁵ @ 125°C (Amps)	DCR (mΩ) @ 20°C	K-factor6
FP0805R1-R03-R	32	23		110	95		823.6
FP0805R1-R06-R	58	42		83	61		823.6
FP0805R1-R07-R	72	52	65	67	49	0.17 ± 17%	823.6
FP0805R1-R10-R	100	72		50	35		823.6
FP0805R1-R20-R	200	144		20	16		823.6

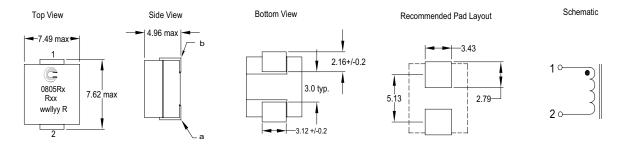
- 1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, $0.10V_{rms}$, 0.0Adc
- 2 Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1 V_{rms} , I_{sat} 1
- 3 $\,$ I_{rms}: DC current for an approximate temperature rise of 40 $^{\circ}$ C without core loss. Derating is necessary for AC currents. PCB pad layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end
- 4 I_{sat}1: Peak current for approximately 20% rolloff at +25°C.
- 5 I_{sat}2: Peak current for approximately 20% rolloff at +125°C.
- 6 K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K * L * \Delta I * 10^{-3}$, B_{p-p} : (Gauss), K: (K-factor from table), L: (inductance in nH), ΔI (peak-to-peak ripple current in amps).
- 7 Part Number Definition: FP0805Rx-Rxx-R
 - FP0805 = Product code and size
 - Rxx= Inductance value in μ H, R = decimal point "-R" suffix = RoHS compliant
- Rx is the DCR indicator

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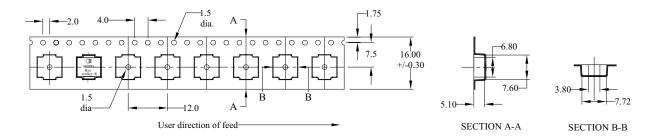
Dimensions - mm



The nominal DCR is measured from point "a" to point"b."

0805Rx (Rx = DCR Indicator) $\mbox{Rxx} = \mbox{Inductance value in } \mbox{μH. (R = Decimal point)}$ $R = Revision\ level$ Part Marking: Coiltronics Logo $wwllyy = Date\ code$

Packaging Information - mm



Supplied in tape-and-reel packaging, 950 parts per reel, 13" diameter reel.

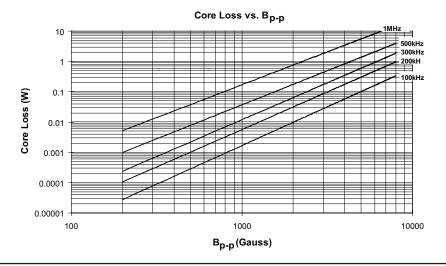
Temperature Rise vs. Total Loss



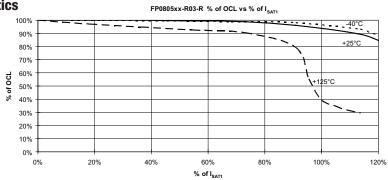
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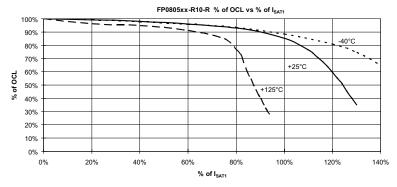


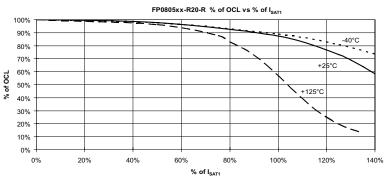
Core Loss



Inductance Characteristics







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Solder Reflow Profile

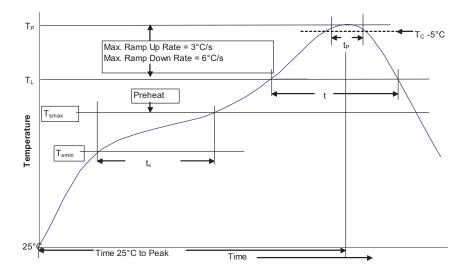


Table 1 - Standard SnPb Solder (T_c)

	Volume	Volume
Package	mm³	mm³
Thickness	<350	≥350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak	• Temperature min. (T _{smin})	100°C	150°C
	Temperature max. (T _{smax})	150°C	200°C
	• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T _{smax} to T _p		3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (TL) Time at liquidous (t _L)		183°C 60-150 Seconds	217°C 60-150 Seconds
Peak package body temperature (T _P)*		Table 1	Table 2
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**
Average ramp-down rate (T _p to T _{smax})		6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.

 $^{^{\}star}$ Tolerance for peak profile temperature ($T_{\rm p}$) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.